#### SCOPE:

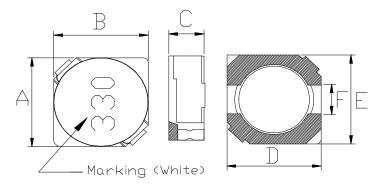
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-6D28-SERIES

#### PRODUCT INDENTIFICATION

#### MSCDRI - 6D28 - 100 M

- (1)
- 2
- 3 4
- 1 Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

## (1) SHAPES AND DIMENSIONS



A: 6.70±0.3 mm
B: 6.70±0.3 mm
C: 3.00 Max. mm
D: 6.50 Typ. mm
E: 6.50 Typ. mm
F: 2.00 Typ. mm

# (2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

**TEST INSTRUMENTS** 

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

## (3) CHARACTERISTICS

(3)-1 Ambient temperature ...... +60°C Max.

(3)-2 Operate temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range ......  $-40^{\circ}$ C  $\sim +125^{\circ}$ C

#### **TABLE 1**

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		
PT/NO.						Marking	
	L(µH)	Tolerance	Frequency	RDC(Ω)Max.	IDC(A)		
MSCDRI-6D28-1R2□	1.2	N	100kHz/0.25V	14m	4.50	1R2	
MSCDRI-6D28-2R2□	2.2	N	100kHz/0.25V	20m	3.50	2R2	
MSCDRI-6D28-3R0□	3.0	N	100kHz/0.25V	24m	3.00	3R0	
MSCDRI-6D28-3R3□	3.3	N	100kHz/0.25V	25m	3.00	3R3	
MSCDRI-6D28-3R6□	3.6	N	100kHz/0.25V	27m	2.60	3R6	
MSCDRI-6D28-3R9□	3.9	N	100kHz/0.25V	27m	2.60	3R9	
MSCDRI-6D28-4R7□	4.7	M,N	100kHz/0.25V	30m	2.50	4R7	
MSCDRI-6D28-5R0□	5.0	N	100kHz/0.25V	31m	2.40	5R0	
MSCDRI-6D28-6R0□	6.0	N	100kHz/0.25V	35m	2.25	6R0	
MSCDRI-6D28-7R3□	7.3	N	100kHz/0.25V	54m	2.10	7R3	
MSCDRI-6D28-8R6□	8.6	N	100kHz/0.25V	58m	1.85	8R6	
MSCDRI-6D28-9R0□	9.0	M,N	100kHz/0.25V	58m	1.85	9R0	
MSCDRI-6D28-100□	10	M,N	100kHz/0.25V	65m	1.70	100	
MSCDRI-6D28-120□	12	M,N	100kHz/0.25V	70m	1.55	120	
MSCDRI-6D28-150□	15	M,N	100kHz/0.25V	84m	1.40	150	
MSCDRI-6D28-180□	18	M,N	100kHz/0.25V	95m	1.32	180	
MSCDRI-6D28-220□	22	M,N	100kHz/0.25V	0.128	1.20	220	
MSCDRI-6D28-270□	27	M,N	100kHz/0.25V	0.142	1.05	270	
MSCDRI-6D28-330□	33	M,N	100kHz/0.25V	0.165	0.97	330	
MSCDRI-6D28-390□	39	M,N	100kHz/0.25V	0.210	0.86	390	
MSCDRI-6D28-470□	47	M,N	100kHz/0.25V	0.238	0.80	470	
MSCDRI-6D28-560□	56	M,N	100kHz/0.25V	0.277	0.73	560	
MSCDRI-6D28-680□	68	M,N	100kHz/0.25V	0.304	0.65	680	
MSCDRI-6D28-820□	82	M,N	100kHz/0.25V	0.390	0.60	820	
MSCDRI-6D28-101□	100	M,N	100kHz/0.25V	0.535	0.54	101	

<sup>※ □</sup> specify the inductance tolerance,M(±20%),N(±30%)

% IDC : Based on inductance change ( $\triangle$ L/Lo : drop 35% Max.) @ambient temperature : 25 $^{\circ}$ C and Based on temperature rise ( $\triangle$ T : 40 $^{\circ}$ C TYP.)



# (4) RELIABILITY TEST METHOD

### **MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	Ţ,			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			



#### **MECHANICAL**

TEST ITEM	SPECIFICATION					
TEST ITEM Resistance to Soldering heat reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering  300  250  Reak temperature 290:30 10 sec  150  Pre-heating  Slow cooling (Stored at room temperature)  2 min 100  2 min or mere  The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.  The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

### **ELECTRICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$ .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^{\circ}\!$
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.



### **ENVIROMENT CHARACTERISTICS**

TEST ITEM				SPECIFICATION				
High temperature	∆L/Lo≦±5%	The sample	The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperat	a temperature of 85±2 $^{\circ}$ C and a normal humidity.					
	There shall be	Upon com	Upon completion of the measurement shall be made after the					
	no mechanical	sample has	sample has been left in a normal temperature and normal					
	damage.	humidity fo	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sample	The sample shall be left for 96±4 hours in an atmosphere with					
storage		a temperat	a temperature of -25±3℃.					
	There shall be	Upon com	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sa	ampl	e has been left in a nori	mal temperature and			
	damage.	normal hur	midit	y for 1 hour.				
Change of	∆L/Lo≦±5%	The sample	e sha	all be subject to 5 conti	nuos cycles, such as shown	]		
temperature		in the table	e 2 b	elow and then it shall be	subjected to standard			
	There shall be	atmospher	ric co	onditions for 1 hour, afte	er which measurement			
	no other dama-	shall be ma	ade.					
	ge of problems							
		_	_	table 2	_			
				Temperature	Duration			
		1	1	<b>−25±3</b> °C	20 in			
			. 1	(Themostat No.1)	30 min.			
		2	,	Standard	No.4 - No.2			
				atmospheric	No.1→No.2			
		3	3	85±2℃	30 min.			
				(Themostat No.2)	J 111111			
		4	4	Standard	No.2→No.1			
				atmospheric	NU.2→NU.1			
Moisture storage	∆L/Lo≦±5%	The sample	e sha	all be left for 96±4 hours	s in a temperature of			
-				umidity(RH) of 90 $\sim$ 95%	-			
	There shall be	_	Upon completion of the test, the measurement shall be made					
	no mechanical	after the sample has been left in a normal temperature and						
	damage.	•						
Test conditions :				-				
The	sample shall be reflow	v soldered on	ito th	e printed circuit board	in every test.			
•								

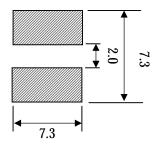


# (5) LAND DIMENSION (Ref.)

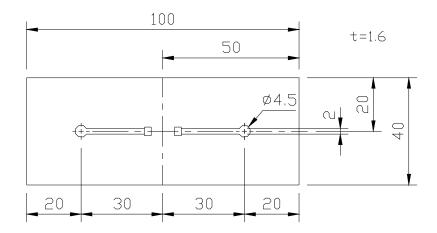
PCB: GLASS EPOXY t=1.6mm

### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm

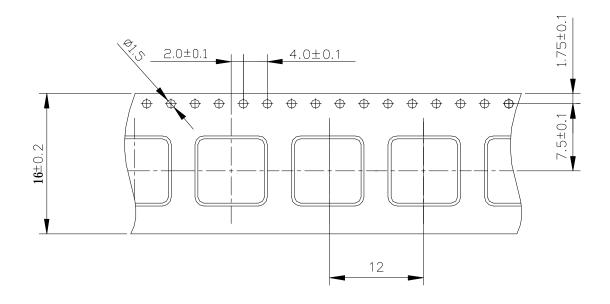


## (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

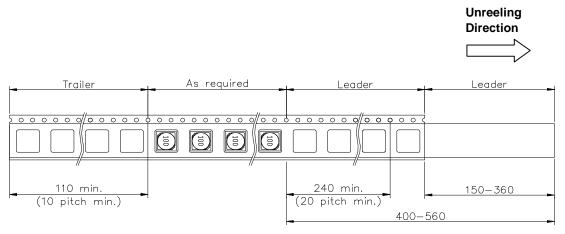


# (6) PACKAGING

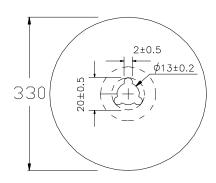
### (6)-1 CARRIER TAPE DIMENSIONS (mm)

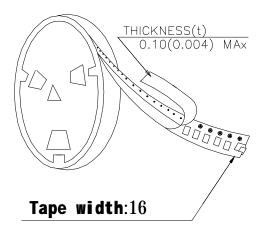


## (6)-2 TAPING DIMENSIONS (mm)



# (6)-3 REEL DIMENSIONS (mm)





# (6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.